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## (54) Title of the invention : METAMATERIALS-ENHANCED PASSIVE RADIATIVE COOLING PANEL

(51) International classification:G02B0001000000, F28F0013180000, B82Y0020000000, G02B0006122000, B32B0027400000(86) International Application No Filing Date:NA(87) International Filing Date:NA(61) Patent of Addition Filing Date:NA(62) Divisional to Filing Date:NA(62) Divisional to Filing Date:NANA:NAFiling Date:NAFiling Date:NAFiling Date:NA	<ul> <li>(71)Name of Applicant : <ul> <li>1)Chitkara University</li> <li>Address of Applicant :Chitkara University, Chandigarh-Patiala</li> <li>National Highway, Village Jhansla, Rajpura, Punjab - 140401,</li> <li>India. Patiala</li></ul></li></ul>
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## (57) Abstract :

A metamaterial passive radiative cooling panel (100) to achieve enhanced cooling efficiency is dissclosed. The panel (100) includes a base material (102) made of a group of metals, ceramics, and polymers, providing essential mechanical support, thermal conductivity, and durability. Additionally, a layer (104) of metamaterial is fabricated on top of the base material, which can be fabricated using various techniques such as lithography, printing, and deposition. The metamaterial layer is selected from a group of photonic crystals, plasmonic materials, and hyperbolic materials, exhibiting a high emissivity at long wavelengths, thereby promoting effective heat dissipation. To further optimize cooling performance, the thickness of the metamaterial layer can be tailored accordingly. The metamaterial passive radiative cooling panel (100) used in energy-efficient buildings, solar panels, and electronic devices, offering a promising solution for passive cooling with a broad range of potential uses.

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